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TO-220 FULLPAK

D²PAK (TO-263)

TO-220AB

SiHP16N50C, SiHB16N50C, SiHF16N50C

Vishay Siliconix

Power MOSFET

FEATURES

- Low figure-of-merit Ron x Qa
- 100 % avalanche tested
- Gate charge improved
- t_{rr}/Q_{rr} improved
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

PRODUCT SUMMARY							
V _{DS} (V) at T _J max.	560						
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.38						
Q _g (Max.) (nC)	68						
Q _{gs} (nC)	17.6						
Q _{gd} (nC)	21.8						
Configuration	Single						

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S

N-Channel MOSFET

ORDERING INFORMATION							
Package	TO-220AB	D ² PAK (TO-263)	TO-220 FULLPAK				
	SiHP16N50C-E3	SiHB16N50C-E3	SiHF16N50C-E3				
Lead (Pb)-free	-	SiHB16N50CTR-E3	-				
	-	SiHB16N50CTL-E3	-				
Lead (Pb)-free and halogen-free	SiHP16N50C-BE3	-	-				

ABSOLUTE MAXIMUM RATINGS (To	; = 25 °C, unle	ess otherwise	noted)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage			V _{DS}	500	V
Gate-source voltage	V _{GS}	± 30	v		
Continuous drain surrant $(T_{1} - 150 ^{\circ}\text{C})^{1/2}$	V at 10 V	T _C = 25 °C		16	
Continuous drain current ($T_J = 150 \text{ °C}$) ^a	V _{GS} at 10 V	T _C = 100 °C		10	А
Pulsed drain current ^c			I _{DM}	40	
Linear derating factor				2	W/°C
Single pulse avalanche energy ^b			E _{AS}	320	mJ
Maximum power dissipation	TO220-AB, D	TO220-AB, D ² PAK (TO-263)		250	w
Maximum power dissipation	TO-220	TO-220 FULLPAK		38	vv
Operating junction and storage temperature range	T _J , T _{stg}	-55 to +150	<u></u>		
Soldering recommendations (peak temperature) ^d	For	10 s		300	U

Notes

a. Limited by maximum junction temperature

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 2.5 mH, $R_g = 25 \Omega$, $I_{AS} = 16$ A

c. Repetitive rating; pulse width limited by maximum junction temperature

d. 1.6 mm from case

1 For technical questions, contact: <u>hvm@vishay.com</u>





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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TO220-AB D ² PAK (TO-263)	TO-220 FULLPAK	UNIT				
Maximum junction-to-ambient	R _{thJA}	62	65					
Maximum junction-to-case (drain)	R _{thJC}	0.5	3.3	°C/W				
Junction-to-ambient (PCB mount) ^a	R _{thJA}	40	-					

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

PARAMETER	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0$	V, I _D = 250 μA	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C, I _D = 1 mA	-	0.6	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} = V	_{GS} , I _D = 250 μΑ	3.0	-	5.0	V
Gate-source leakage	I _{GSS}	V _G	_S = ± 30 V	-	-	± 100	nA
Zero gate voltage drain current	1	$V_{DS} = 5$	00 V, V _{GS} = 0 V	-	-	50	
zero gate voltage drain current	IDSS	V _{DS} = 400 V, V	′ _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 8 A	-	0.31	0.38	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} =	50 V, I _D = 3 A	-	3	-	S
Dynamic							
Input capacitance	C _{iss}	V	_{GS} = 0 V,	-	1900	-	pF
Output capacitance	C _{oss}	V	_{DS} = 25 V,	-	230	-	
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz		-	24	-	1
Total gate charge	Qg			-	45	68	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 16 \text{ A}, V_{DS} = 400 \text{ V}$		-	18	-	nC
Gate-drain charge	Q _{gd}			-	22	-	
Turn-on delay time	t _{d(on)}			-	27	-	
Rise time	t _r	V _{DD} = 2	50 V, I _D = 16 A,	-	156	-	- ns
Turn-off delay time	t _{d(off)}	$R_{g} = 9.7$	I Ω, V _{GS} = 10 V	-	29	-	
Fall time	t _f			-	31	-	
Gate input resistance	R _g	f = 1 M	Hz, open drain	-	1.6	-	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	١ _S	MOSFET symbo showing the		-	-	16	^
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	30	A
Body diode voltage	V _{SD}	T _J = 25 °C,	_S = 10 A, V _{GS} = 0 V	-	-	1.8	V
Body diode reverse recovery time	t _{rr}			-	555	-	ns
Body diode reverse recovery charge	Q _{rr}		= I _S , dl/dt = 100 A/μs, / _B = 20 V	-	5.5	-	μC
Body diode reverse recovery current	I _{RRM}	- 	K - 20 V	-	18	-	А

Note

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

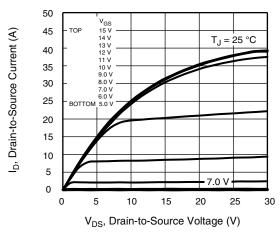


Fig. 1 - Typical Output Characteristics (TO-220)

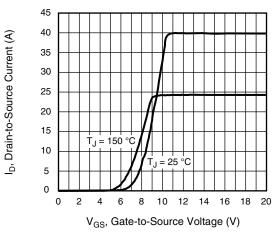


Fig. 3 - Typical Transfer Characteristics

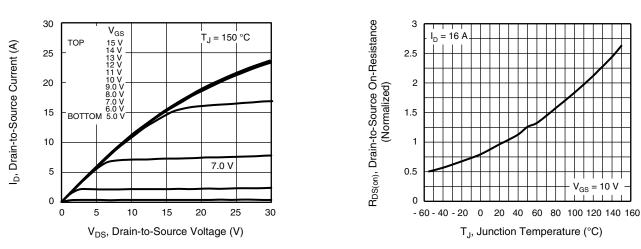


Fig. 2 - Typical Output Characteristics (TO-220)

Fig. 4 - Normalized On-Resistance vs. Temperature



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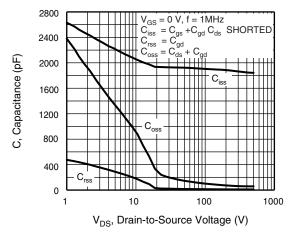


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

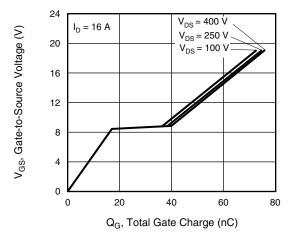


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

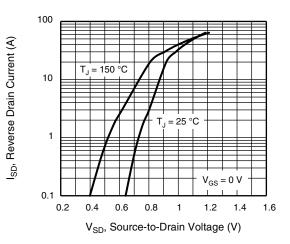


Fig. 7 - Typical Source-Drain Diode Forward Voltage

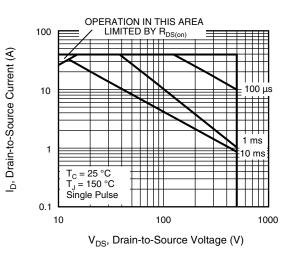


Fig. 1 - Maximum Safe Operating Area (TO-220AB, D²PAK)

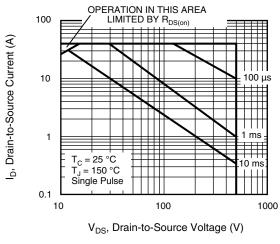


Fig. 2 - Maximum Safe Operating Area (TO-220 FULLPAK)

S21-1104-Rev. C, 15-Nov-2021

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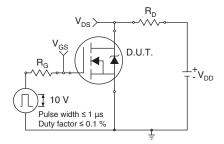


Fig. 10a - Switching Time Test Circuit

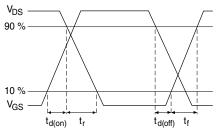


Fig. 10b - Switching Time Waveforms

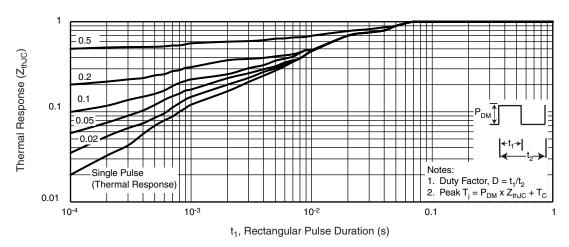


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case (TO-220AB, D²PAK)

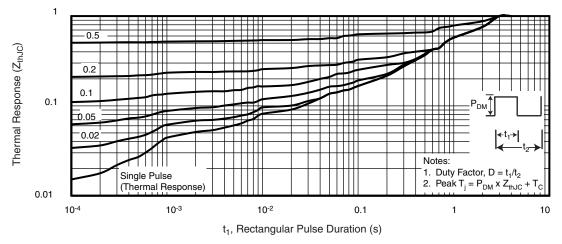


Fig. 3 - Maximum Effective Transient Thermal Impedance, Junction-to-Case (TO-220 FULLPAK)

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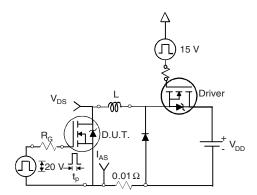


Fig. 13a - Unclamped Inductive Test Circuit

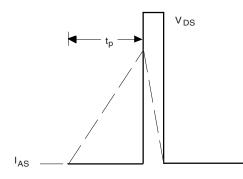


Fig. 13b - Unclamped Inductive Waveforms

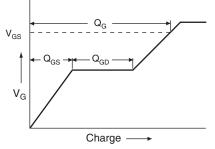


Fig. 14a - Basic Gate Charge Waveform

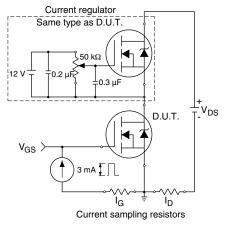
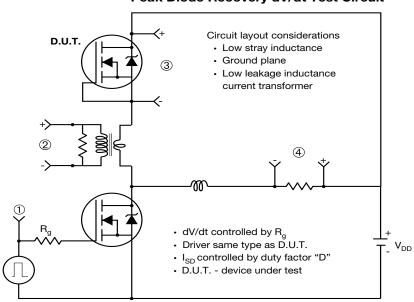


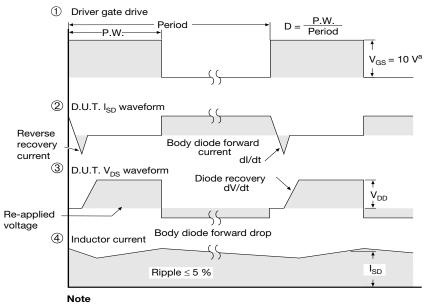
Fig. 14b - Gate Charge Test Circuit



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a. V_{GS} = 5 V for logic level devices

Fig. 15 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØP	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

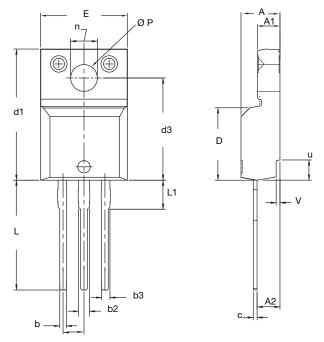
- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

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OPTION 2: FACILITY CODE = Y



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1st character located at the 2nd row of the unit marking

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TO-263AB (HIGH VOLTAGE)

<u>′3</u>`

 $\overline{4}$

-A

(Datum A)

4L1

			2 x b2 2 x b	Detail A	2)	a -1	Rot		Seatin A1	ng plane
	MILLIN	METERS	INC	HES			MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
A1	0.00	0.25	0.000	0.010		Е	9.65	10.67	0.380	0.420
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-
b1	0.51	0.89	0.020	0.035		е	2.54	BSC	0.100) BSC
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.625
b3	1.14	1.73	0.045	0.068		L	1.78	2.79	0.070	0.110
С	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.066
c1	0.38	0.58	0.015	0.023		L2	-	1.78	-	0.070
c2	1.14	1.65	0.045	0.065		L3	0.25	BSC	0.010) BSC
D	8.38	9.65	0.330	0.380		L4	4.78	5.28	0.188	0.208
		15 Can 00								

A

Gauge plane

0° to 8°

ECN: S-82110-Rev. A, 15-Sep-08 DWG: 5970

Notes

2. Dimensions are shown in millimeters (inches).

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.



Package Information

B

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^{1.} Dimensioning and tolerancing per ASME Y14.5M-1994.

^{3.} Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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